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STATEMENT BY APPLICANT**  
(Not for submission under 37 CFR 1.99)

Application Number	10542040
Filing Date	2006-02-06
First Named Inventor	John Mize
Art Unit	1795
Examiner Name	Jason Berman
Attorney Docket Number	H0004870.70759 US -4015

**U.S. PATENTS**

Examiner Initial*	Cite No	Patent Number	Kind Code <sup>1</sup>	Issue Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
	1					

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**U.S. PATENT APPLICATION PUBLICATIONS**

Examiner Initial*	Cite No	Publication Number	Kind Code <sup>1</sup>	Publication Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
	1	20080149598	A1	2008-06-26	Tokyo Electron Limited	
	2	20070273287	A1	2007-11-29	Nagisa Kuwahara, et al	
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Receipt date: 04/21/2009

Application Number 10542040

10542040 - GAU: 1795

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Art Unit 1795

Examiner Name Jason Berman

Attorney Docket Number H0004870.70759 US -4015

6	20070240795	A1	2007-10-18	Ulvac Materials, Inc.	
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20070166477

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## **FOREIGN PATENT DOCUMENTS**

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Examiner Signature	/Jason Berman/	Date Considered	07/15/2009
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